

## Transient Voltage Suppressors

### General Description

The ESD8D24CS protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. They feature large cross-sectional area junctions for conducting high transient currents, offer desirable electrical characteristics for board level protection, such as fast response time, low operating voltage. It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



### Applications

- Cellular phones
- Portable devices
- Digital cameras
- Power supplies



Pin Configuration

### Features

- Small Body Outline Dimensions
- Low Body Height
- Peak Power up to 300 Watts @ 8 x 20  $\mu$ s Pulse
- Low Leakage current
- Response Time is Typically < 1 ns

### Ordering information

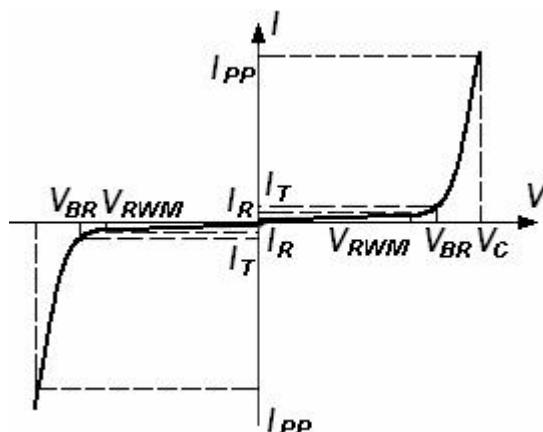
Device	Marking	Shipping
LESD8D24CS	CG4	10000/Tape&Reel

### Absolute Ratings ( $T_{amb}=25^{\circ}C$ )

Symbol	Parameter	Value	Units
$P_{PP}$	Peak Pulse Power ( $t_p = 8/20 \mu s$ )	300	W
$T_L$	Maximum lead temperature for soldering during 10s	260	°C
$T_{stg}$	Storage Temperature Range	-55 to +150	°C
$T_{op}$	Operating Temperature Range	-40 to +125	°C
$T_j$	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD)	air discharge contact discharge	±20 ±15
$I_{PPM}$	IEC61000-4-5 (8/20uS)	4	A

### Electrical Parameter

Symbol	Parameter
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current
V <sub>c</sub>	Clamping Voltage @ I <sub>PP</sub>
V <sub>RWM</sub>	Working Peak Reverse Voltage
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>
I <sub>T</sub>	Test Current
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>



### Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Device	V <sub>RWM</sub> (V)	I <sub>R1</sub> (uA) @ V <sub>RWM</sub>	V <sub>BR</sub> (V) @ I <sub>T</sub> (Note 1)	I <sub>T</sub>	V <sub>c</sub> (V) @ Max I <sub>PP</sub> *	I <sub>PP</sub> (A)*	P <sub>PK</sub> (W)*	C (pF)
	Max	Max	Min	mA	Max	Max	Max	Max
ESD8D24CS	24.0	0.1	26.5	1.0	60.0	4.0	300	10

\*Surge current waveform per Figure 1.

1. V<sub>BR</sub> is measured with a pulse test current I<sub>T</sub> at an ambient temperature of 25°C.

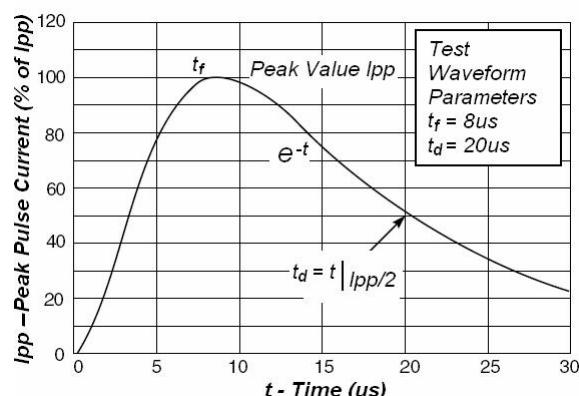


Fig1. IEC61000-4-5 Waveform

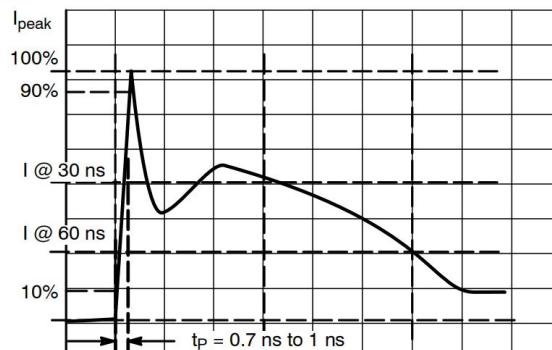
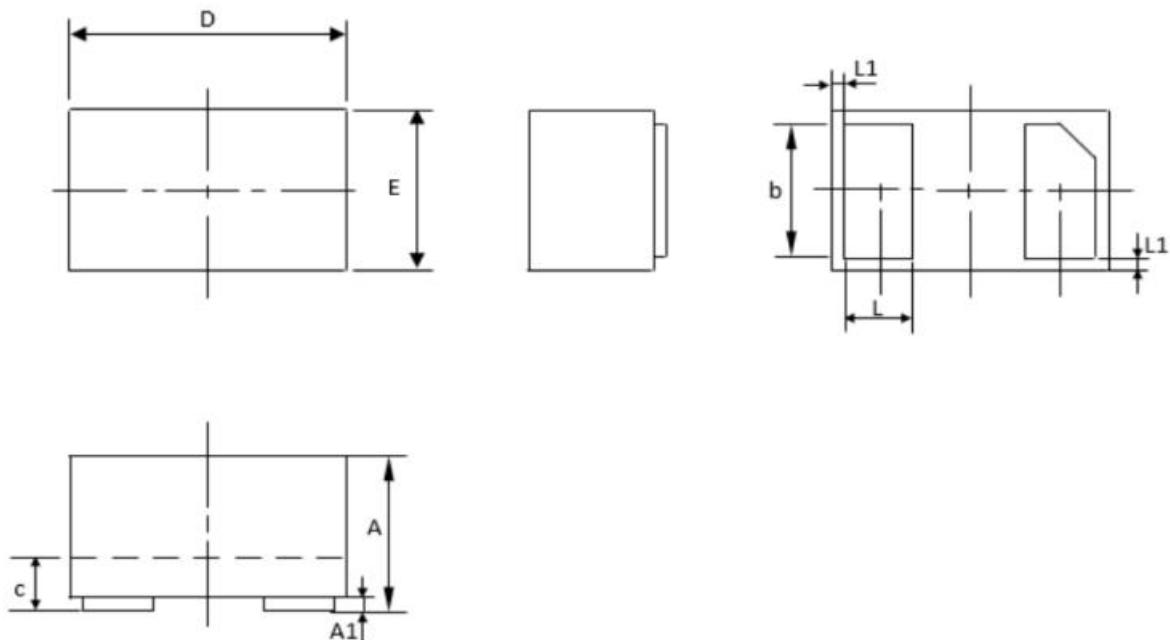


Fig2.IEC61000-4-2 Waveform

**OUTLINE AND DIMENSIONS**

1-Line bidirectional ESD Protection Diode

**SOD882**


SOD882 (mm)			
Dim	Min	Typ.	Max
A	0.46	0.48	0.50
A1	0	0.02	0.05
b	0.45	0.5	0.55
c	0.1	0.12	0.14
D	0.95	1.00	1.05
E	0.55	0.60	0.65
L	0.20	0.25	0.30
L1	0.035	0.05	0.065
h	0.07	0.12	0.17